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PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

947

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10034498	01/03/2002	438	151	2812	Smith

**\*\*APPLICANTS:** Yamazaki Shunpei; Murakami Satoshi; Ohnuma Hideto; Nakamura Osamu; Tanaka Koichiro; Arai Yasuyuki; 2824

**\*\*CONTINUING DATA VERIFIED:**

None

2824

**\*\* FOREIGN APPLICATIONS VERIFIED:**

JAPAN 2001-010858 01/18/2001

2824

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO 740756-2417
35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		
Verified and Acknowledged Examiners's initials 2824		
TITLE : Method of manufacturing semiconductor device		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Total Claims	Print Claim for O.G.
<b>ISSUE FEE</b>		<b>DRAWING</b>	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
		Application Examiner	
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		<b>PREPARED FOR ISSUE</b>	
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